D.C. gas discharge display panel with internal memory.

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Description

The present invention relates to D.C. gas discharge display panels with internal memory.

In gas discharge display panels in which two orthogonal sets of conductors are disposed on opposite sides of an ionizable gas, a potential applied to one of the anodes and one of the cathodes will result in the breakdown of the gas at the intersection of those electrodes, and the resulting gas discharge will emit light in the visible region of the spectrum.

In AC gas discharge display panels, the electrodes are isolated from the gas by a dielectric. This dielectric capacitor acts as the memory element of the cells and also provides the current limiting mechanism. During each half-cycle of the AC excitation signal, a wall charge will build up on the surface of the dielectric in contact with the gas, and this wall charge will oppose the drive signal, permitting use of lower voltage signals to sustain or maintain the discharge. This is advantageous in an AC gas discharge display panel because the wall charge will rapidly extinguish the gas discharge and assist in breaking down the gas during the next half-cycle of the AC signal. Since each breakdown during each half-cycle of operation produces light emission from the selected cell or cells, a flicker-free display can be achieved by operating the display at a relatively high frequency, e.g., 30 to 50 kilocycles. A disadvantage of AC gas discharge display panels is that the AC drive signal generation systems are quite expensive and the brightness and efficiency are low.

An alternative to the AC gas discharge display panel is a D.C. gas discharge panel which, like the AC panel, consists of two sets of orthogonally arranged conductors enclosing an ionizable gas. In conventional D.C. gas discharge display panels, the metal electrodes are in direct contact with the discharge. Therefore, the cathodes are subjected to constant bombardment by gas ions during D.C. operation. These gas ions may have sufficient kinetic energy to sputter atoms from the cathode surface. While many of the sputtered atoms will be deflected by collisions with gas atoms, some will escape collision with the gas atoms and be deposited on other surfaces within the device. Continued sputtering will result in the production of electrical leakage paths between conductors and in the trapping of inert gas by sputtered deposits, with consequent loss of gas pressure. These sputtering effects will result in the exhaustion of the usable life of the device and they will also make cell switching more difficult.

Certain techniques have been proposed to control sputtering of the cathodes in a D.C. gas discharge display panel, but none have proven satisfactory. If a protective layer overlying the cathodes is employed in a D.C. gas discharge display panel, such a layer cannot be a dielectric, because a dielectric will isolate the gas discharge cell from the D.C. excitation voltage. In contrast to the AC panel, in which a surface charge build-up is desirable in order to aid in extinguishing the discharge and in causing gas breakdown during the next half cycle of operation, a surface charge build-up in a D.C. operated panel will decrease the effective potential applied to the gas until the net voltage falls below the minimum voltage required to sustain a gas discharge, at which time the cell will turn "off".

A somewhat similar problem has also been recognized in AC gas discharge display panels. In AC panels, the dielectric glass layer overlying the metal electrodes and isolating them from the gas can become dissociated and sputtered due to ion bombardment from the discharge. Therefore, the dielectric glass layer in AC panels is covered with a protective refractory layer made of a material having a high binding energy such as magnesium oxide. In D.C. gas discharge display panels, on the other hand, a protective dielectric layer of a high binding energy metal oxide, such as magnesium oxide, overlying the metal cathodes cannot be employed to correct cathode sputtering, because any surface charge build-up is undesirable in D.C. operation.

For D.C. gas discharge display panels operated in a storage mode, a current limiting element, usually a resistor, must be used in series with each cell to increase the overall impedance of the cell, since the impedance of the cell due to discharge alone is generally low. This gives the cells internal memory and, once the cells are switched on, the discharges can be sustained by a fixed D.C. voltage until erasure is required.

The invention seeks to provide a D.C. gas discharge display panel with internal memory, in which the cathode conductors are protected from ion bombardment induced sputtering and a uniform and stable resistance is incorporated in series with each discharge cell.

According to the invention, a D.C. gas discharge display panel with internal memory, comprising an ionizable gas in a gas chamber formed by a pair of glass plates, an array of parallel cathode conductors disposed on one of the glass plates, and an array of parallel anode conductors disposed on the other glass plate, the conductor arrays being disposed substantially orthogonal to each other, and the intersections of the cathode and anode conductors defining gas discharge cells, is characterized by the provision of a layer of resistive material overlying the anode conductor array to provide a uniform and stable resistance to and to limit the current through each of the cells during discharge, and a cermet layer overlying the cathode conductor array.

Thus, the cathode conductor electrodes are isolated from the discharge by the cermet layer, protecting the metal cathodes from ion bombardment induced sputtering. The resistive layer provides a uniform and stable resistor in series with each discharge cell. In the resistive layer, the amount of metal incorporated in the insulator is such that surface charge build-up during D.C. operation is prevented, while the layer provides sufficient resistance in series with each discharge.
cell. In this way, a uniform and stable resistor will be internally produced, while providing isolation between individual cathodes as well as protection from ion bombardment. Further the high surface resistivities of the layers will tend to eliminate discharge spreading along the metal conductors, thus eliminating the necessity of physical barriers between adjacent discharge cells which are commonly provided in known D.C. gas discharge display panels.

The scope of the invention is defined by the appended claims; and how it can be carried into effect is hereinafter particularly described with reference to the accompanying drawings, in which:

Figure 1 is a sectional view of a portion of a D.C. gas discharge display panel according to the present invention:

Figure 2 is a diagrammatic illustration of the elevation of a D.C. gas discharge display panel according to the present invention with circuitry connected.

A direct current gas discharge display panel according to the invention comprises a gas filled envelope bounded by a pair of glass plates 2 and 3 (Fig. 1) which carry on their respective internal surfaces, and which thus act as substrates, for, deposited cathode and anode electrodes 4 and 5, respectively. The gas in the discharge gap 30 between the plates is ionizable. The anode electrodes 5 form an array of substantially parallel anode conductors and the cathode electrodes 4 from an orthogonal array of substantially parallel cathode conductors. The crossover regions of the anode and cathode conductors define discharge cells.

The anodes 5 are covered with a resistive layer 10 consisting of a mixture of a metal, such as chromium, and an insulator, such as silicon dioxide (SiO2), while the cathodes 4 are isolated from the discharge by a cermet layer 12 consisting of a mixture of a metal, such as nickel, gold or silver, and an insulator having a high secondary electron emission coefficient, such as magnesium oxide (MgO). The amount of metal incorporated into the insulator is such that the layer exhibit enough conductivity to prevent the build-up of positive or negative surface charge, yet exhibit sufficient resistance to limit the cell current in the "on" state. This will result in a reduction in the power requirements of the gas discharge panel. A suitable level of cell current may be approximately 10 to 30 microamperes at the sustaining voltage level.

In manufacturing the gas discharge display panel, according to the present invention, anodes 5 and cathodes 4 are first formed on plate glass substrates 2 and 3 respectively, by any of a number of well known processes such as sputtering, vacuum deposition and photo etching. Suitable electrodes would be stripes of 100 to 1,000 nm thickness of gold, aluminium or nickel. Transparent conductive material such as indiumtin oxide can be used to form the anode electrodes 6, and should have a resistance of less than 5,000 ohms per line.

Then a resistive layer 10 which consists of a mixture of a metal, such as chromium, and an insulator, such as SiO2, is deposited over the anodes 5 and a cermet layer 12 consisting of a mixture of a metal, such as nickel, gold or silver, and an insulator, such as MgO, is deposited over the cathodes 4. The layer 10 should be approximately 20 to 50% by volume, for example, chromium and should have a thickness of 100 to 1,000 nm, depending upon the value of resistance desired. The cermet layer 12 should be approximately 15 to 50% by volume, for example, nickel, gold or silver and should have a thickness range of 10 to 1,000 nm.

The layers 10 and 12 are applied to the surfaces of the glass plates 2 and 3 by any convenient means, for example, by co-evaporation of the metals and insulators using direct heat and electron beam, by co-sputtering the metals and insulators by various techniques such as simultaneously DC sputtering the metal and r.f. sputtering the insulator or r.f. sputtering mixtures of the metals and insulators.

The preferred thickness of the ionizable gas layer in the discharge gap 30 is between 0.1016 mm and 0.2032 mm (4 to 8 mils), with anode and cathode arrays having a centre-to-centre spacing of about 0.508 mm (20 mils).

Each anode electrode of one array of a gas discharge display panel thus made is connected to a horizontal selection circuit 14 (Fig. 2), whereby a select or non-select voltage may be applied to individual anodes 4, 5, 6, 7, ..., 4, 5, 6. Each cathode electrode of the other array is connected to a vertical selection circuit 16, whereby a select or non-select voltage may be applied to individual cathodes 4, 7, 5, 8, 4, ..., 4, 7. The selection circuits 14 and 16 are controlled by a display control 18.

The details of the display control, horizontal selection circuit and vertical selection circuit do not constitute a part of the present invention and need not be described herein. The circuitry necessary to operate the D.C. gas discharge display panel according to the present invention would be obvious to one of ordinary skill in the art.

In a D.C. gas discharge display panel, a firing voltage Vf is required to initiate the breakdown of the gas. After initiation of the discharge, the cell voltage can be reduced without extinguishing the discharge. At some point, determined primarily by the value of cell resistance, the voltage reaches an extinguishing voltage Vxe at which level the illumination resulting from the gas discharge ceases. Voltage thresholds typical of a D.C. gas discharge panel using a neon-argon Penning gas mixture, operated at a pressure of about 40,000 Pa (300 Torr) and having 0.1016mm (4 mil) wide electrodes on 0.762mm (30 mil) centre-to-centre spacings and a 0.1016mm (4 mil) discharge gap are a firing voltage Vf of approximately 135 volts, an extinguishing voltage Vxe of approximately 115
volts, with a D.C. voltage level $V_a$ of approximately 120—125 volts being sufficient to sustain the discharge once initiated.

The gas discharge display panel is addressed by selectively applied voltage pulses superimposed on the D.C. sustaining voltage $V_s$. In order to write a selected intersection, voltage pulses $V_a$ are applied to the selected anode and the selected cathode in addition to the D.C. sustain voltage $V_s$ between the anodes and cathodes. In this way, the cell at the selected intersection receives a voltage increment of 2$V_s$, equal to or exceeding $V_t - V_s$ to implement a write operation. Cells at non-selected intersections receive the half select pulses of amplitude $V_s$ which must be kept less than $V_t - V_s$ to avoid unwanted writing. It should be noted that $V_t$ and $V_s$ define the boundary conditions of the firing voltage spread. Similarly, to erase a selected intersection, voltage pulses $V_a$ are applied to the selected anode and the selected cathode such that the cell at the selected intersection receives a voltage increment of 2$V_s$. The signal level 2$V_s$ must exceed $V_t - V_s$ in order to implement an erase operation. Cells at non-selected intersections receive the half-select pulses of amplitude $V_s$ which must be kept less than $V_t - V_s$ to avoid non-selected erasing $V_t$ max and $V_s$ min define the boundary conditions of the spread of the extinguishing voltage.

For a firing voltage $V_a$ of 135 volts and an extinguishing voltage $V_e$ of 115 volts, the D.C. sustaining voltage $V_s$ continuously applied to the anodes $A_1$, $A_2$, ..., $A_6$, through the horizontal selection circuit 14 can be 125 volts, with the selection circuit 14 being capable of imposing an additional plus or minus 5 volt pulse on the 125 volt sustaining voltage in response to information from the display control 18. The vertical selection circuit 16 can apply a reference level such as ground potential to the cathodes $C_1$, $C_2$, ..., $C_4$, and also be capable of selectively applying plus or minus 5 volt pulses to the cathodes in response to information provided by the display control. In order to initiate gas discharge at the intersection of, for example, anode $A_1$ and cathode $C_1$, the horizontal selection circuit 14 will apply an additional +5 volt pulse to anode $A_6$, while maintaining anodes $A_2$, $A_3$, ..., $A_5$, at the 125 volt sustaining level. This pulse can be, for example, approximately 100 to 150 microseconds in duration. Vertical selection circuit 16 will then apply a −5 volt pulse to cathode $C_1$, while maintaining cathodes $C_2$, $C_3$, ..., $C_4$, at ground potential. Intersections $A_1$ and $C_1$ will be subject to a total potential difference of 130 volts, a potential which is insufficient to initiate gas discharge. Intersection $A_1$ will be subject to a 135 volt potential difference. $V_t - V_s$ will occur. Energization of selected intersections on the $A_1$ anode, the $A_6$ anode is maintained at a potential of 125 volts. Since all the cathodes are maintained at either 0

or minus 5 volt levels, the potential difference at each of the intersections along the $A_1$ anode will be either 120 or 125 volts, sufficient to sustain the discharges along anode $A_6$, once initiated.

In order to erase selected intersections, the horizontal selection circuit 14 applies a −5 volt erase pulse to selected anode $A_6$, while the vertical selection circuit 16 applies a +5 volt erase pulse to selected cathode $C_4$. The potential at the intersection of selected anode $A_6$ and cathode $C_4$ is only 115 volts, thus extinguishing the discharge. At all non-selected intersections, the potential difference will remain at 120 volts and existing discharges will be sustained.

The above description of the "memory" mode of operation of the D.C. gas discharge display panel according to the present invention is given by way of example only. The firing and extinguishing voltages of the gas discharge cells should be determined empirically to each other and the D.C. sustaining voltage and the amplitudes of the write and erase pulses applied from the horizontal and vertical selection circuits should be specified according to the empirically determined characteristics of the cells. For example, it may be that the gas discharge cells have an extinguishing voltage of 110 volts rather than 115 volts and the D.C. sustaining voltage and the amplitudes of the write and erase pulses will then have to be altered accordingly.

The use of the present invention provides many advantages. For example, layers consisting of mixtures of metals and insulators are used to provide stable and uniform resistors in series with each discharge and to protect the metal cathodes from ion bombardment induced sputtering. The high secondary electron emission coefficients of the gas contacting layers result in a lower D.C. voltage being required in order to sustain the discharges. Further, display panels fabricated according to the present invention, exhibit small spreads in values of both the firing and extinguishing voltages thus ensuring small write and erase pulses.

Claims

1. A D.C. gas discharge display panel with internal memory, comprising an ionizable gas in a gas chamber (30) formed by a pair of glass plates (2, 3), an array of parallel cathode conductors (4) disposed on one of the glass plates, and an array of parallel anode conductors (5) disposed on the other glass plate, the conductor arrays being disposed substantially orthogonal to each other, and the intersections of the cathode and anode conductors defining gas discharge cells, characterized by the provision of a layer (10) of resistive material overlying the anode conductor array to provide a uniform and stable resistance to and to limit the current through each of the cells during discharge, and a cermet layer (12) overlying the cathode conductor array.

2. A panel according to Claim 1 in which the gas contacting resistive material layer has sufficient
conductivity to prevent the build-up of surface charge during operation.
3. A panel according to any preceding claim, in which the resistive material consists of a mixture of a metal and an insulator.
4. A panel according to Claim 3, in which the metal comprises chromium, nickel, gold, silver or combinations thereof.
5. A panel according to Claim 3 or 4, in which the insulator comprises silicon dioxide, magnesium dioxide or compounds thereof.
6. A panel according to Claim 5, in which the resistive material consists of 20 to 50% by volume of chromium in silicon dioxide.
7. A panel according to Claim 1, in which the resistive material layer (10) is composed of semiconductor material.
8. A panel according to any preceding claim, in which the cermet layer includes a material having a high coefficient of secondary emission to provide low voltage operation of the gaseous discharge display panel.
9. A panel according to any preceding claim in which the cermet layer consists of 15 to 50% by volume of nickel, gold or silver in magnesium oxide.

Revendications

1. Un panneau d'affichage à décharge gazeuse opérant en courant continu et avec mémoire interne, comprenant un gaz ionisant dans une chambre (30) formée par une paire de plaques de verre (2, 3), un groupe de conducteurs cathodiques parallèles (4) disposés sur une des plaques de verre et un groupe de conducteurs anodiques parallèles (6) disposés sur l'autre plaque de verre, les groupes de conducteurs étant disposés sensiblement orthogonalement entre eux, et les intersections des conducteurs cathodiques et anodiques définissant des cellules de décharge gazeuse, caractérisée par la présence d'une couche de matière résistive (10) recouvrant le groupe de conducteurs anodiques pour opposer une résistance uniforme et stable au courant, et pour limiter celui-ci dans chacune des cellules en cours de décharge, et une couche cermet (12) recouvrant le groupe de conducteurs cathodiques.
2. Un panneau selon la revendication 1, dans lequel la couche de matière résistive en contact avec le gaz a une conductivité suffisante pour empêcher l'accumulation d'une charge de surface en cours de fonctionnement.
3. Un panneau selon une quelconque des revendications précédentes, dans lequel la matière résistive se compose d'un mélange d'un métal et d'un isolant.
4. Un panneau selon la revendication 3, dans lequel le métal comprend le chrome, le nickel, l'or, l'argent ou leurs combinaisons.
5. Un panneau selon la revendication 3 ou 4, dans lequel l'isolant comprend le dioxyde de silicium, le dioxyde de magnésium ou leurs composés.
6. Un panneau selon la revendication 5, dans lequel la matière résistive se compose de 20 à 50% en volume de chrome dans le dioxyde de silicium.
7. Un panneau selon la revendication 1, dans lequel la couche de matière résistive (10) est composée d'une matière semiconductrice.
8. Un panneau selon l'une des revendications précédentes, dans lequel la couche cermet comprend une matière ayant un coefficient élevé d'émission secondaire pour assurer un fonctionnement en basse tension du panneau d'affichage à décharge gazeuse.
9. Un panneau selon l'une des revendications précédentes, dans lequel la couche cermet se compose de 15 à 50% en volume de nickel, d'or ou d'argent dans le dioxyde de magnésium.

Patentansprüche

2. Tafel nach Anspruch 1, bei welcher die mit dem Gas in Berührung stehende Widerstands materialschicht eine Leitfähigkeit hat, die ausreicht, den Aufbau von Oberflächenladungen während des Betriebs zu verhindern.
3. Tafel nach irgendeinem vorstehenden Anspruch, bei welcher das Widerstandsmaterial aus einem Gemisch aus einem Metall und einem Isolator besteht.
5. Tafel nach Anspruch 3 oder 4, bei welcher der Isolator Siliciumdioxid, Magnesiumdioxid oder Zusammensetzungen derselben umfasst.
6. Tafel nach Anspruch 5, bei welcher das Widerstandsmaterial aus 20 bis 50 Volumen- prozent Chrom in Siliciumdioxid besteht.
7. Tafel nach Anspruch 1, bei welcher die Widerstandsmaterialschicht (10) aus einem Halbleitermaterial aufgebaut ist.
8. Tafel nach irgendeinem vorstehenden Anspruch, bei welcher die Cermet-Schicht ein Material mit hohem Sekundäremissionskoeffizienten zur Lieferung eines Betriebs der Gasent-
ladungsanzeigetafel bei niedriger Spannung enthält.
9. Tafel nach irgendeinem vorstehenden

Anspruch, bei welcher die Cermet-Schicht aus 15 bis 50 Volumenprozent Nickel, Gold oder Silber in Magnesiumoxid besteht.